



INTERNATIONAL CONFERENCE ON SPUTTER TECHNOLOGY

## HIPIMS Conference becomes part of International Conference on Sputter Technology

June 19th – 20th 2019 | Braunschweig, Germany  
Venue: Town Centre »Stadthalle Braunschweig«

## CONFERENCE ANNOUNCEMENT AND CALL FOR PAPERS

### TOPICS OF SPUTTER TECHNOLOGY CONFERENCE 2019

The ST Conference 2019 will provide a forum for high level networking and exchange of knowledge and expertise in the field of Sputtering between researchers, scientists, and engineers from industry, research labs, and academia. The conference will cover the full range of research and application from fundamental scientific aspects to industrial applications and products.

Special emphasis will be given to commercial plasma and material development, commercial equipment and industrial processes. The conference will focus on the following topics:

- **T1: HIPIMS**
- **T2: Simulation & Modelling**
- **T3: Reactive Sputtering**
- **T4: Plasma Diagnostic & fundamental aspects**
- **T5: Industrial Applications**
- **T6: Smart Surfaces**

### CALL FOR PAPERS

As a truly international conference, the ST Conference 2019 will present the most recent results of scientific research as well as

new applications in the field of Sputter technology. If you wish to present your latest research results or if you have developed a new application, your contribution will be highly welcome.

We encourage you to submit your abstract to the following e-mail address: [info@st-conference.eu](mailto:info@st-conference.eu).

Abstracts (max. 1 page incl. illustration) should be written in English and should include name, address, phone and fax numbers, as well as the e-mail address of the contact author. Please classify your abstract into one of the topic. If you are not sure about your choice you can classify it into two of the topics.

The scientific committee will review all submitted contributions. Depending on the topic of your paper, the committee will decide whether your paper should be presented orally or as a poster. We expect that the authors of the paper will submit it in a scientific journal.

### CONTACT (SUBMISSION OF ABSTRACT)

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### Call for Papers – Deadlines

Submission of 1 page abstract: **14<sup>th</sup> February 2019**

Acceptance notification of authors: **11<sup>th</sup> March 2019**

### Young Scientist Award

- **Eligibility: Age ≤ 35**
- Submission of **full paper** by deadline
- **self application** by online registration

Organisation



### PARTICIPATION 19<sup>TH</sup> AND 20<sup>TH</sup> JUNE 2019

#### CONFERENCE FEES

Industry	€ 500
Academia	€ 400
Students	€ 160

The conference fee includes all technical sessions, abstract booklet and conference proceedings, lunches and coffee breaks as well as the conference evening with the young scientist award ceremony.

#### EXHIBITION AND SPONSORING

- Exhibition Space (1 person included) € 500
- Exhibition Space (2 person included) € 750
- Sponsoring + Exhibition Space\* (1 person included) € 1400
- Sponsoring + Exhibition Space\* (2 person included) € 1600

\*Premium Sponsoring & Exhibition possible. Please inform yourself on [st-conference.eu](http://st-conference.eu) or [www.inplas.de](http://www.inplas.de).

### REGISTRATION | EXHIBITION & SPONSORING

If you wish to join the group of sponsors, please register until

**28<sup>th</sup> February 2019**

More information online:

[www.inplas.de](http://www.inplas.de) and [st-conference.eu](http://st-conference.eu)



SOCIETY OF  
VACUUM  
COATERS

### SVC TUTORIAL COURSES

**17<sup>th</sup> and 18<sup>th</sup> June 2019**

Main Sponsor

Venue: Fraunhofer-Institute IST,  
Bienroder Weg 54 E, BS

17<sup>th</sup> June Magnetron Sputtering | **C-323**

18<sup>th</sup> June Application of Reactive Sputtering | **C-338**  
(half-day/in the morning)

Practice and Applications of High Power Impulse  
Magnetron Sputtering (HIPIMS) | **C-333**  
(half-day/afternoon)

For detailed information please visit: [www.svc.org](http://www.svc.org) and [www.inplas.de](http://www.inplas.de).